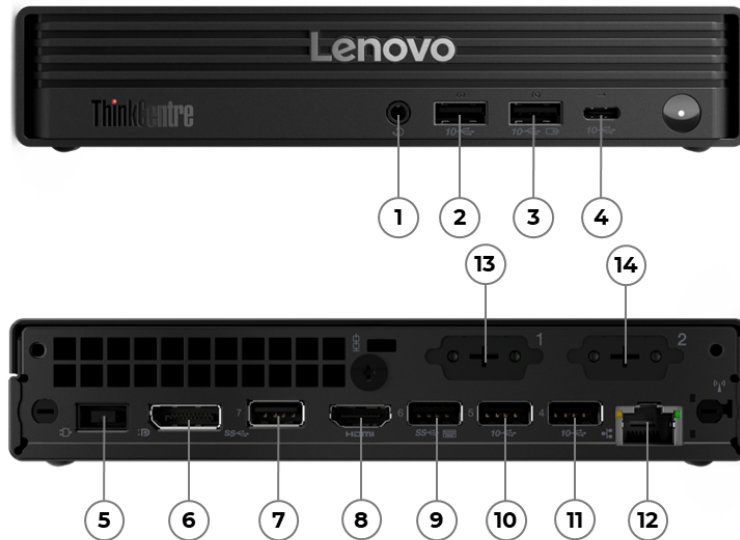


## OVERVIEW



1. Headphone / microphone combo jack (3.5mm)	8. HDMI 2.1 TMDS
2. USB-A (USB 10Gbps)	9. USB-A (USB 5Gbps), with Smart Power On
3. USB-A (USB 10Gbps), 5V@2.1A charging	10. USB-A (USB 10Gbps)
4. USB-C (USB 10Gbps), 5V@0.9A charging	11. USB-A (USB 10Gbps)
5. Power connector	12. Ethernet (GbE RJ-45)
6. DisplayPort 1.4a (HBR2)	13. Punch out port 1 *
7. USB-A (USB 5Gbps)	14. Punch out port 2 *

Notes:

- Items with \* are only available on selected models
- Port 10 and port 11 are USB-A (Hi-Speed USB) on models with Intel B860 Chipset

## PERFORMANCE

### Processor

#### Processor Family

Intel® Core™ Ultra 3 / 5 / 7 Processor (Series 2)

#### Processor

Processor Name	Cores	Threads	Base Frequency	Max Frequency	Cache	Processor Graphics	NPU	Overall TOPS
Core Ultra 3 205 <sup>[1]</sup>	8 (4 P-core + 4 E-core)	8	P-core 3.8GHz / E-core 3.2GHz	P-core 4.9GHz / E-core 4.4GHz	16MB L2 Cache / 15MB Intel® Smart Cache	Intel® Graphics	Intel® AI Boost, up to 13 TOPS	Up to 22 TOPS
Core Ultra 3 205T	8 (4 P-core + 4 E-core)	8	P-core 2.7GHz / E-core 2.4GHz	P-core 4.9GHz / E-core 4.4GHz	16MB L2 Cache / 15MB Intel® Smart Cache	Intel® Graphics	Intel® AI Boost, up to 13 TOPS	Up to 22 TOPS
Core Ultra 5 225 <sup>[2]</sup>	10 (6 P-core + 4 E-core)	10	P-core 3.3GHz / E-core 2.7GHz	P-core 4.9GHz / E-core 4.4GHz	22MB L2 Cache / 20MB Intel® Smart Cache	Intel® Graphics, up to 4 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 23 TOPS
Core Ultra 5 225T	10 (6 P-core + 4 E-core)	10	P-core 2.5GHz / E-core 1.9GHz	P-core 4.9GHz / E-core 4.4GHz	22MB L2 Cache / 20MB Intel® Smart Cache	Intel® Graphics, up to 4 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 23 TOPS
Core Ultra 5 235 <sup>[3]</sup>	14 (6 P-core + 8 E-core)	14	P-core 3.4GHz / E-core 2.9GHz	P-core 5.0GHz / E-core 4.4GHz	26MB L2 Cache / 24MB Intel® Smart Cache	Intel® Graphics, up to 6 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 27 TOPS
Core Ultra 5 235T	14 (6 P-core + 8 E-core)	14	P-core 2.2GHz / E-core 1.6GHz	P-core 5.0GHz / E-core 4.4GHz	26MB L2 Cache / 24MB Intel® Smart Cache	Intel® Graphics, up to 6 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 27 TOPS
Core Ultra 5 245T	14 (6 P-core + 8 E-core)	14	P-core 2.2GHz / E-core 1.7GHz	P-core 5.1GHz / E-core 4.5GHz	26MB L2 Cache / 24MB Intel® Smart Cache	Intel® Graphics, up to 8 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 29 TOPS
Core Ultra 7 265 <sup>[4]</sup>	20 (8 P-core + 12 E-core)	20	P-core 2.4GHz / E-core 1.8GHz	Max Turbo up to 5.3GHz / P-core 5.2GHz / E-core 4.6GHz	36MB L2 Cache / 30MB Intel® Smart Cache	Intel® Graphics, up to 8 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 33 TOPS
Core Ultra 7 265T	20 (8 P-core + 12 E-core)	20	P-core 1.5GHz / E-core 1.2GHz	Max Turbo up to 5.3GHz / P-core 5.2GHz / E-core 4.6GHz	36MB L2 Cache / 30MB Intel® Smart Cache	Intel® Graphics, up to 8 TOPS	Intel® AI Boost, up to 13 TOPS	Up to 33 TOPS

Notes:

[1], [2], [3], [4] The device integrates a 65W CPU in 35W power mode, offering identical performance to regular 35W processors

### AI (Artificial Intelligence)

#### AI PC Category

AI PC<sup>[1]</sup>

#### NPU

Integrated Intel® AI Boost, up to 13 TOPS

Notes:

[1] AI PCs have a NPU capable of 10+ TOPs to run the Copilot assistant by pressing the optional Microsoft® Copilot key or using Win + C.

## Operating System

### Operating System

- Windows® 11 Pro
- Windows® 11 Home
- Windows® 11 IoT Enterprise LTSC 2024
- Ubuntu Linux
- No preload operating system

## Graphics

### Graphics

Graphics	Type	Memory	Max Resolution	Connector	Key Features
Integrated Intel® Graphics	Integrated	Shared	1920x1080@60Hz(VGA), 4096x2160@60Hz(DP 1.4a HBR2), 4096x2160@60Hz(HDMI® TMDS), 7680x4320@60Hz(HDMI® FRL), 7680x4320@60Hz(Thunderbolt™ 4), 4096x2160@60Hz(USB-C® with DP function)	1x HDMI® 2.1 TMDS, 1x DP 1.4a HBR2, optional port 1 (VGA / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / DP 1.4a HBR2 / USB-C® with DP 1.4a HBR2 function), optional port 2 (VGA / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / Thunderbolt™ 4 / DP 1.4a HBR2)	DirectX® 12

## Monitor Support

### Monitor Support

Supports up to 4 independent displays via (onboard DP, onboard HDMI®, optional punch out port 1 [VGA / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / DP 1.4a HBR2 / USB-C® with DP 1.4a HBR2 function], and optional punch out port 2 [VGA / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / Thunderbolt™ 4 / DP 1.4a HBR2])

## Chipset

### Chipset

- Intel® B860 chipset<sup>[1]</sup>
- Intel® Q870 chipset<sup>[2]</sup>

Notes:

[1] For models: 13HA, 13HK

[2] For models: 13A4, 13A5, 13A7, 13BJ, 13E8

## Memory

### Max Memory<sup>[1]</sup>

Up to 64GB (2x 32GB DDR5 SODIMM)

### Memory Slots

Two DDR5 SODIMM slots, dual-channel capable

### Memory Type

DDR5-5600

Notes:

[1] The max memory is based on the test results with current Lenovo® memory offerings.

## Storage

### Max Storage Support<sup>[1]</sup>

Up to two drives, 2x M.2 2280 SSD

- M.2 2280 SSD up to 2TB

### Storage Type<sup>\*\*\*</sup>

Disk Type	Interface	Security

M.2 2280 SSD	PCIe® NVMe®, PCIe® 4.0 x4	Opal
M.2 2280 SSD	PCIe® NVMe®, PCIe® 4.0 x4 Performance	Opal

**RAID**

RAID 0/1 is supported on models with Intel® Q870 Chipset (RAID preset only available via special bid models)

Notes:

[1] The max capacity of each disk type is based on the test results with current Lenovo® storage offerings.

**Removable Storage****Optical**

None

**Card Reader**

No card reader

**Multi-Media****Audio Chip\*\***

- High Definition (HD) Audio, Realtek® ALC233VB or Conexant CX11771 codec
- 24-bit DAC supports 44.1K/48K/96K sample rate, 2 channel DAC supports 24-bit PCM format
- 16-bit ADC supports 44.1K/48K/96K sample rate, 2 stereo ADC supports 16-bit PCM format

**Speakers\*\***

- Premium single speaker, 2W x1
- Single speaker, 2W x1

**Power Supply****Power Supply\*\*[1]**

Power	Type	Efficiency	Key Features
65W	Adapter	89%	Autosensing
90W	Adapter	89%	Autosensing
135W	Adapter	90%	Autosensing
No power adapter	-	-	-

Notes:

[1] When work with TIO monitor, an appropriate power adapter is needed. Customer may need to:

- Order a Tiny for TIO MT (13A6, 13A7, 13HC, 13HD, 13HG, 13HH) models
- Or order an additional 135W power adapter, if original power adapter is 90W or 65W

For detailed information, please refer to [ThinkCentre® M70q Gen 6 Adapter Matrix](#)

**DESIGN****Input Device****Keyboard\*\***

- Lenovo® Calliope Keyboard (USB connector), black
- Lenovo® Traditional Keyboard (USB connector), black
- Wireless EOS Keyboard, black
- No keyboard

**Mouse\*\***

- Lenovo® Calliope Mouse (USB connector), black
- Wireless EOS Mouse, black
- No mouse

**Mechanical****Form Factor**

Tiny (1L)

**Dimensions (WxDxH)<sup>[1]</sup>**

Models	Dimensions
Tiny only	179 x 182.9 x 36.5 mm (7.05 x 7.2 x 1.44 inches)

**Packaging Dimensions (WxDxH)**

Tiny with Stand: 140 x 488 x 266 mm (5.51 x 19.21 x 10.47 inches)

**Weight<sup>[2]</sup>**

Models	Weight
Tiny only	Around 1.18 kg (2.6 lbs)

**Packaging Weight**

Around 3.12kg (6.88 lbs)

**Case Color**

Raven black

**Expansion Slots**

Three M.2 slots (one for WLAN, two for SSD)<sup>[3]</sup>

**EOU**

(Optional) toolless chassis open (toolless chassis screw required)

**Stand**

- Vertical stand
- No stand

**Mounting**

- Supports VESA mount 100mm
- None

**Others**

- (Optional) Dust filter
- (Optional) Power adapter cage
- Supports Smart Power On

**Notes:**

[1] The system dimensions may vary depending on configurations.

[2] The system weight is approximate and based on results in Lenovo® lab, which varies depending on the source of component, variance of the distribution of each component, and manufacturing process. It may not be the exact weight for each specific model.

[3] M.2 slot for SSD is M.2 PCIe® 4.0 x4 slot, supports up to 64Gbps on NVMe® drives

## CONNECTIVITY

### Network

**WLAN + Bluetooth®\*\*<sup>[1]</sup>**

- Intel® Wi-Fi® 6 AX203, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.2, M.2 card
- Realtek® Wi-Fi® 6E RTL8852CE, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3, M.2 card
- Intel® Wi-Fi® 6E AX211, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3, Intel® vPro® technology support, M.2 card<sup>[2]</sup>
- Intel® Wi-Fi® 6E AX211, 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3, M.2 card
- Realtek® Wi-Fi® 7 RTL8922AE, 802.11be 2x2 Wi-Fi® + Bluetooth® 5.4
- No WLAN and Bluetooth®

**Onboard Ethernet\*\***

- Gigabit Ethernet, Intel® Ethernet Connection I219-LM, 1x RJ-45, supports Wake-on-LAN<sup>[3]</sup>
- Gigabit Ethernet, Realtek® RTL8111K, 1x RJ-45, supports Wake-on-LAN<sup>[4]</sup>

**Optional Ethernet**

- 2.5 Gigabit Ethernet, Realtek® RTL8125BGS, 1x RJ-45, supports Wake-on-LAN
- No optional Ethernet

**Notes:**

[1] Wi-Fi® operation (including Wi-Fi® 6, Wi-Fi® 6E, Wi-Fi® 7, etc.) is subject to the regulatory requirements of each country. Bluetooth® may operate at a lower version than hardware design depending on the factors such as operating system, driver, etc.

[2] Intel® vPro® platform requires the hardware and software necessary to deliver the manageability use cases, security features, system performance, and stability that define the platform. For detailed vPro® support information, please refer to the System Management section.

[3] For models with Intel® Q870 Chipset only

[4] For models with Intel® B860 Chipset only

## Ports<sup>[1]</sup>

### Front Ports

- 1x USB-C® (USB 10Gbps / USB 3.2 Gen 2), with 5V@0.9A charging
- 2x USB-A (USB 10Gbps / USB 3.2 Gen 2), one supports Always On and 5V@2.1A charging
- 1x headphone / microphone combo jack (3.5mm)

### Rear Ports

- 2x USB-A (Hi-Speed USB / USB 2.0) (models with Intel® B860 Chipset)<sup>[2]</sup>
- 2x USB-A (USB 10Gbps / USB 3.2 Gen 2) (models with Intel® Q870 Chipset)<sup>[3]</sup>
- 2x USB-A (USB 5Gbps / USB 3.2 Gen 1), one supports Smart Power On
- 1x HDMI® 2.1 TMDS
- 1x DisplayPort™ 1.4a (HBR2)
- 1x Ethernet (GbE RJ-45)

### Optional Rear Ports

- Punch out port 1 (one of VGA / DisplayPort™ 1.4a HBR2 / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / serial / 2.5GbE RJ-45 / USB-C® (USB 10Gbps / USB 3.2 Gen 2) with DisplayPort™ 1.4a HBR2 function, PD-in 100W (20V@5A) and PD-out 15W (5V@3A))
- Punch out port 2 (one of VGA / DisplayPort™ 1.4a HBR2 / HDMI® 2.1 TMDS / HDMI® 2.1 FRL / serial / 2.5GbE RJ-45 / Thunderbolt™ 4 (USB4® 40Gbps))
- 2x USB-A (USB 10Gbps / USB 3.2 Gen 2), occupies port 1 and 2

### Notes:

[1] The transfer speed of following ports will vary and, depending on many factors, such as the processing speed of the host device, file attributes and other factors related to system configuration and your operating environment, will be slower than theoretical speed.

USB 2.0: 480 Mbit/s;

USB 3.2 Gen 1 (SuperSpeed USB 5Gbps, formerly USB 3.0 / USB 3.1 Gen 1): 5 Gbit/s;

USB 3.2 Gen 2 (SuperSpeed USB 10Gbps, formerly USB 3.1 Gen 2): 10 Gbit/s;

USB4® 20Gbps / USB 3.2 Gen 2x2 (SuperSpeed USB 20Gbps): 20 Gbit/s;

USB4® 40Gbps (USB 40Gbps): 40 Gbit/s;

Thunderbolt™ 3/4: 40 Gbit/s.

Thunderbolt™ 5: 80 Gbit/s (bidirectional), up to 120 Gbit/s in bandwidth boost mode for video-intensive applications.

[2], [3] Occupied port 10 and port 11. For detailed information, please see the [overview](#).

## SECURITY & PRIVACY

### Security

#### Security Chip

Discrete TPM 2.0, TCG certified, FIPS 140-2 certified

#### Physical Locks

Kensington® Security Slot™, 3 x 7 mm

#### Chassis Intrusion Switch

Chassis intrusion switch<sup>[1]</sup>

#### Fingerprint Reader

No fingerprint reader

#### BIOS Security

- Absolute persistence module
- Administrator password
- Boot sequence control
- Boot without keyboard and mouse

- Configuration change detection
- Certificate-based BIOS authentication
- Cover tamper detected
- Intel® BIOS guard
- Individual USB port disablement
- Hard disk password
- Power-on password
- Smart USB protection (allows keyboard / mouse only, blocks all storage devices)
- Self-healing BIOS
- Secure boot
- Secure wipe
- More BIOS security features, please visit [BIOS Simulator](#)<sup>[2]</sup>

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**Notes:**

[1] Chassis intrusion switch is hardware ready function and needs to be special bid or manually enabled in BIOS.

[2] The BIOS simulator is just for reference. Default settings and some options may vary depending on the hardware, operating system and BIOS version.

## MANAGEABILITY

### System Management

#### System Management<sup>[1][2]</sup>

- Intel® vPro® Enterprise
- Non-vPro®

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**Notes:**

[1] Intel® vPro® offers a superset of DASH's defined capabilities.

[2] Intel® vPro® platform require an eligible Intel® processor, a supported operating system, Intel® LAN and/or WLAN silicon, firmware enhancements, and other hardware and software necessary to deliver the manageability use cases, security features, system performance, and stability that define the platform. See [Intel® vPro® Platform](#) for details.

## SERVICE

### Warranty<sup>[1]</sup>

#### Base Warranty\*\*

- 1-year courier or carry-in service
- 1-year limited onsite service
- 3-year courier or carry-in service
- 3-year limited onsite service
- No base warranty

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**Notes:**

[1] The warranty upgrades may be bundled with some models, please check the "Included upgrade" column in the specific model's configurations. For more service extensions, please go to <https://smartfind.lenovo.com/>. To learn more details of warranty policy, please access <https://support.lenovo.com/warrantylookup/warrantypolicy>.

## OPERATING REQUIREMENTS

### Operating Environment

#### Temperature

- Operating: 5°C (41°F) to 35°C (95°F)
- Storage: -40°C (-40°F) to 60°C (140°F)

#### Relative Humidity

- Operating: 20% to 80%
- Storage: 10% to 90%

#### Altitude

- Operating: 0 m (0 ft) to 3048 m (10,000 ft)

- Storage: 0 m (0 ft) to 12192 m (40,000 ft)

## ENVIRONMENTAL

### Sustainability

#### Material

60% PIC recycled plastic with 30% OBP used in cushion  
30% OBP used in bag  
FSC certified paper in packaging

## CERTIFICATIONS

### Green Certifications<sup>[1]</sup>

#### Green Certifications

- (Optional) ENERGY STAR® 9.0
- (Optional) EPEAT™ Gold Registered
- RoHS compliant
- TCO Certified, generation 10

Notes:

[1] The items listed under the "Green Certifications" section may not only refer to certification but also registration or self-declaration. For ESG & regulatory compliance documents, please visit <https://compliance.lenovo.com>.

### Other Certifications

#### Other Certifications

(Optional) TÜV Rheinland® Ultra Low Noise

#### Mil-Spec Test

MIL-STD-810H military test passed (Low Pressure [Altitude], High Temperature, Low Temperature, Temperature Shock, Humidity, Sand and Dust, Vibration, Shock, Solar Radiation, Contamination by Fluids, Salt Fog)

- Feature with \*\* means that only one option listed under the feature can be configured on selected models. Please refer to the model configuration for specific information.
- Feature with \*\*\* means that one or more options listed under the feature can be configured on selected models. Please refer to the model configuration for specific information.
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